20-bit Universal Bus Driver with 3-state Outputs

HITACHI

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Description

This 20-bit universal bus driver is designed for 2.3 V to 3.6 V V_{CC} operation.

Data flow from A to Y is controlled by the output enable (\overline{OE}) input. The device operates in the transparent mode when the latch enable (\overline{LE}) input is low. The A data is latched if the clock (CLK) input is held at a high or low logic level. If \overline{LE} is high, the A data is stored in the latch flip flop on the low to high transition of CLK. When \overline{OE} is high, the outputs are in the high impedance state.

To ensure the high impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current sinking capability of the driver.

Active bus hold circuitry is provided to hold unused or floating inputs at a valid logic level.

Features

- $V_{CC} = 2.3 \text{ V} \text{ to } 3.6 \text{ V}$
- Typical V_{OL} ground bounce < 0.8 V (@V_{CC} = 3.3 V, Ta = 25°C)
- Typical V_{OH} undershoot > 2.0 V (@V_{CC} = 3.3 V, Ta = 25°C)
- High output current ± 24 mA (@V_{CC} = 3.0 V)
- Bus hold on data inputs eliminates the need for external pullup / pulldown resistors



Function Table

Inputs		Output Y			
ŌĒ	LE	CLK	Α		
Н	Х	Х	Х	Z	
L	L	Х	L	L	
L	L	Х	Н	Н	
L	Н	\uparrow	L	L	
L	Н	\uparrow	Н	Н	
L	н	Н	Х	Y ₀ *1	
L	Н	L	Х	Y ₀ *2	

H : High level

L : Low level

X : Immaterial

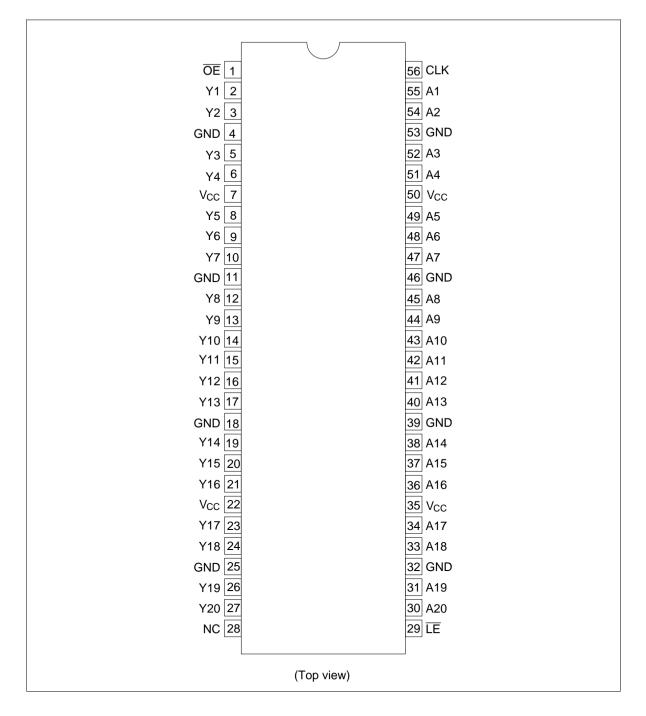
Z : High impedance

 \uparrow : Low to high transition

Notes: 1. Output level before the indicated steady state input conditions were established, provided that CLK is high before LE goes low.

2. Output level before the indicated steady state input conditions were established.

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions	
Supply voltage	V _{cc}	-0.5 to 4.6	V		
Input voltage ^{*1}	V	-0.5 to 4.6	V		
Output voltage *1, 2	Vo	–0.5 to V _{cc} +0.5	V		
Input clamp current	I _{IK}	-50	mA	V ₁ < 0	
Output clamp current	Ι _{οκ}	±50	mA	$V_{\rm o}$ < 0 or $V_{\rm o}$ > $V_{\rm cc}$	
Continuous output current	I _o	±50	mA	$V_{o} = 0$ to V_{cc}	
V _{cc} , GND current / pin	$I_{\rm CC}$ or $I_{\rm GND}$	±100	mA		
Maximum power dissipation P_T at Ta = 55°C (in still air) ^{*3}		1	W	TSSOP	
Storage temperature	Tstg	-65 to 150	°C		

Notes: Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute maximum rated conditions for extended periods may affect device reliability.

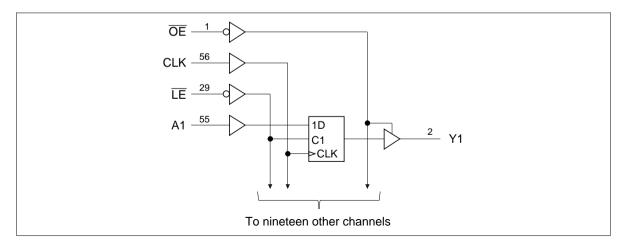
- 1. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.
- 2. This value is limited to 4.6 V maximum.
- 3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage	V _{cc}	2.3	3.6	V	
Input voltage	V	0	V _{cc}	V	
Output voltage	Vo	0	V _{cc}	V	
High level output current	I _{он}	—	-12	mA	V _{cc} = 2.3 V
		_	-12		V _{cc} = 2.7 V
		_	-24		V _{cc} = 3.0 V
Low level output current	I _{ol}	—	12	mA	V _{cc} = 2.3 V
		_	12		V _{cc} = 2.7 V
		_	24		V _{cc} = 3.0 V
Input transition rise or fall rate	Δt / Δv	0	10	ns / V	
Operating temperature	Та	-40	85	°C	

Recommended Operating Conditions

Note: Unused control inputs must be held high or low to prevent them from floating.

Logic Diagram



Item	Symbo	l V _{cc} (V)	Min	Мах	Unit	Test Conditions
Input voltage	$V_{\rm IH}$	2.3 to 2.7	1.7	_	V	
		2.7 to 3.6	2.0	_		
	V _{IL}	2.3 to 2.7	_	0.7	_	
		2.7 to 3.6		0.8	_	
Output voltage	V _{OH}	2.3 to 3.6	V _{cc} -0.2	_	V	I _{OH} = -100 μA
		2.3	2.0	_	_	$I_{OH} = -6 \text{ mA}, V_{IH} = 1.7 \text{ V}$
		2.3	1.7	_		I _{OH} = -12 mA, V _{IH} = 1.7 V
		2.7	2.2	_		$I_{OH} = -12 \text{ mA}, V_{IH} = 2.0 \text{ V}$
		3.0	2.4	_	_	$I_{OH} = -12 \text{ mA}, V_{IH} = 2.0 \text{ V}$
		3.0	2.0	_		$I_{OH} = -24 \text{ mA}, V_{IH} = 2.0 \text{ V}$
	V _{OL}	2.3 to 3.6	_	0.2		I _{oL} = 100 μA
		2.3	_	0.4	_	$I_{oL} = 6 \text{ mA}, V_{IL} = 0.7 \text{ V}$
		2.3	_	0.7		$I_{oL} = 12 \text{ mA}, V_{IL} = 0.7 \text{ V}$
		2.7	_	0.4	_	I _{oL} = 12 mA, V _{IL} = 0.8 V
		3.0	_	0.55	_	I _{oL} = 24 mA, V _{IL} = 0.8 V
Input current	I _{IN}	3.6	_	±5	μΑ	$V_{IN} = V_{CC}$ or GND
	I IN (hold)	2.3	45	_	_	V _{IN} = 0.7 V
		2.3	-45	_	_	V _{IN} = 1.7 V
		3.0	75	_		V _{IN} = 0.8 V
		3.0	-75	_	_	V _{IN} = 2.0 V
		3.6	_	±500	_	$V_{IN} = 0$ to 3.6 V ^{*1}
Off state output current	I _{oz}	3.6		±10	μΑ	$V_{OUT} = V_{CC} \text{ or } GND$
Quiescent supply current	I _{cc}	3.6	_	40	μΑ	$V_{IN} = V_{CC}$ or GND
	$\Delta I_{\rm CC}$	3.0 to 3.6	_	750	μA	V_{IN} = one input at (V _{cc} -0.6) V, other inputs at V _{cc} or GND

Electrical Characteristics (Ta = -40 to 85° C)

Note: 1. This is the bus hold maximum dynamic current required to switch the input from one state to another.

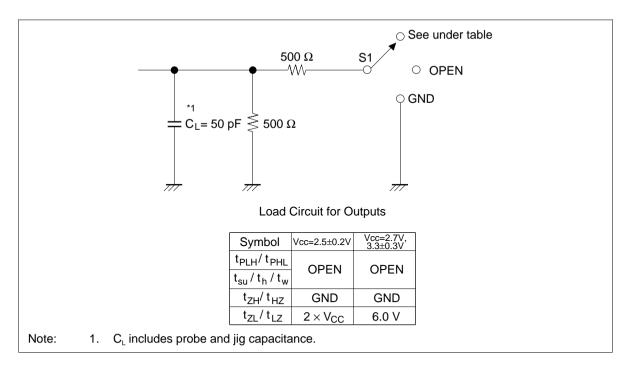
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Unit	FROM (Input)	TO (Output)
Maximum clock frequency	f _{max}	2.5±0.2	150	_	_	MHz		
		2.7	150	—	—			
		3.3±0.3	150	_	—			
Propagation delay time	t _{PLH}	2.5±0.2	1.0	_	4.2	ns	А	Y
	t _{PHL}	2.7	—	_	4.2			
		3.3±0.3	1.0	_	3.6			
		2.5±0.2	1.3	_	5.0		LE	Y
		2.7	_	—	4.9			
		3.3±0.3	1.3	_	4.2			
		2.5±0.2	1.4	—	5.5		CLK	Y
		2.7	_	_	5.2			
		3.3±0.3	1.4	—	4.5			
Output enable time	t _{zH}	2.5±0.2	1.4	—	5.5	ns	ŌĒ	Y
	t _{zL}	2.7	_	—	5.6			
		3.3±0.3	1.1	_	4.6			
Output disable time	t _{HZ}	2.5±0.2	1.0	—	4.5	ns	ŌĒ	Y
	t _{LZ}	2.7	_	_	4.3			
		3.3±0.3	1.3	_	3.9	_		
Input capacitance	C _{IN}	3.3	_	3.5		pF	Control inp	outs
		3.3	_	6.0	_		Data input	S
Output capacitance	Co	3.3		7.0		pF	Outputs	

Switching Characteristics (Ta = -40 to 85° C)

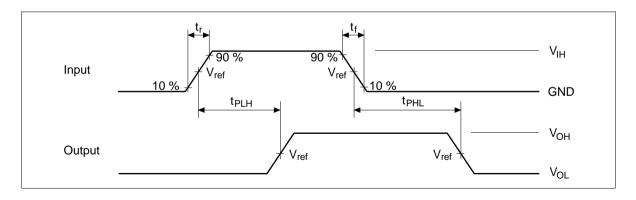
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Unit	FROM (Input)
Setup time	t _{su}	2.5±0.2	1.4	_	_	ns	Data before CLK↑
		2.7	1.7	_	_		
		3.3±0.3	1.5	_	_	_	
		2.5±0.2	1.2	_	_		Data before LE↑
		2.7	1.6				CLK "H"
		3.3±0.3	1.3				
		2.5±0.2	1.4				Data before $\overline{\text{LE}}^{\uparrow}$
		2.7	1.5	_			CLK "L"
		3.3±0.3	1.2	_			
Hold time	t _h	2.5±0.2	0.9	—		ns	Data after CLK↑
		2.7	0.9	_	_		
		3.3±0.3	0.9	—	_		
		2.5±0.2	1.1	—			Data after $\overline{\text{LE}}^{\uparrow}$
		2.7	1.1	_	_		CLK "H" or "L"
		3.3±0.3	1.1	_			
Pulse width	t _w	2.5±0.2	3.3	—		ns	LE "L"
		2.7	3.3	—			
		3.3±0.3	3.3				
		2.5±0.2	3.3	—			CLK "H" or "L"
		2.7	3.3	—			
		3.3±0.3	3.3				

Switching Characteristics (Ta = -40 to 85° C) (cont)

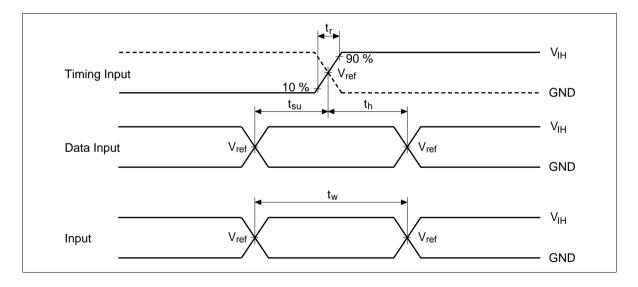
Test Circuit



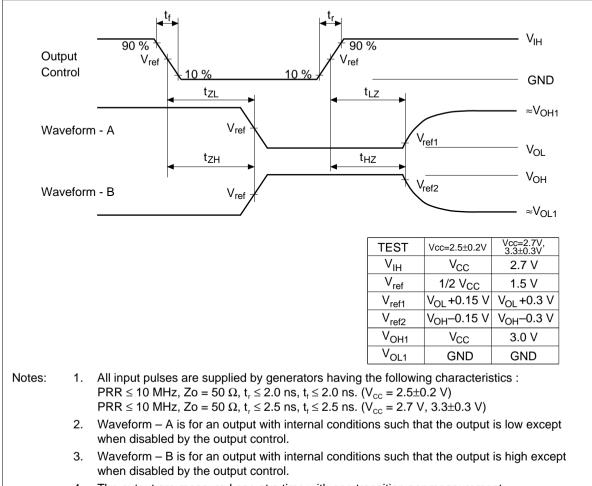
Waveforms - 1



Waveforms - 2



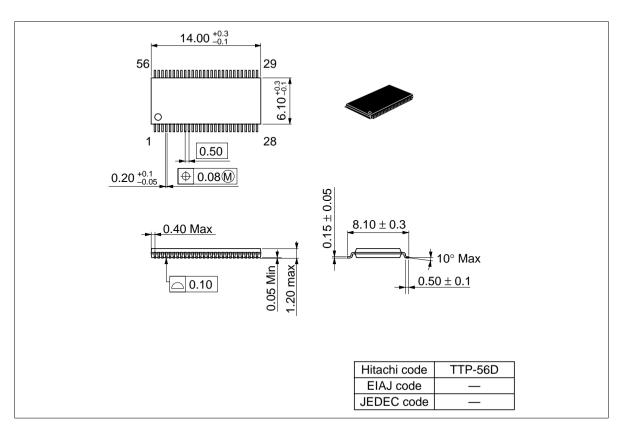
Waveforms - 3



4. The output are measured one at a time with one transition per measurement.

Package Dimensions

Unit : mm



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